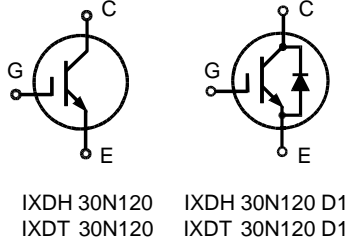


# High Voltage IGBT with optional Diode

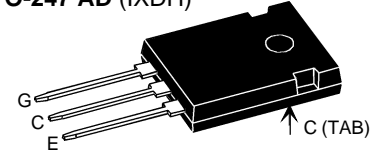
Short Circuit SOA Capability  
Square RBSOA

**IXDH 30N120**  
**IXDH 30N120 D1**  
**IXDT 30N120**  
**IXDT 30N120 D1**

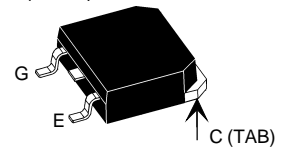
$V_{CES} = 1200\text{ V}$   
 $I_{C25} = 60\text{ A}$   
 $V_{CE(sat) typ} = 2.4\text{ V}$



**TO-247 AD (IXDH)**



**TO-268 AA (IXDT)**



G = Gate,  
C = Collector ,  
E = Emitter  
TAB = Collector

Symbol	Conditions	Maximum Ratings	
$V_{CES}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	1200	V
$V_{CGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GE} = 20\text{ k}\Omega$	1200	V
$V_{GES}$	Continuous	$\pm 20$	V
$V_{GEM}$	Transient	$\pm 30$	V
$I_{C25}$	$T_C = 25^\circ\text{C}$	60	A
$I_{C90}$	$T_C = 90^\circ\text{C}$	38	A
$I_{CM}$	$T_C = 90^\circ\text{C}$ , $t_p = 1\text{ ms}$	76	A
<b>RBSOA</b>	$V_{GE} = \pm 15\text{ V}$ , $T_J = 125^\circ\text{C}$ , $R_G = 47\ \Omega$ Clamped inductive load, $L = 30\ \mu\text{H}$	$I_{CM} = 50$ $V_{CEK} < V_{CES}$	A
<b><math>t_{SC}</math> (SCSOA)</b>	$V_{GE} = \pm 15\text{ V}$ , $V_{CE} = V_{CES}$ , $T_J = 125^\circ\text{C}$ $R_G = 47\ \Omega$ , non repetitive	10	$\mu\text{s}$
<b><math>P_C</math></b>	$T_C = 25^\circ\text{C}$	IGBT Diode	300 135 W W
<b><math>T_J</math></b>		-55 ... +150	$^\circ\text{C}$
<b><math>T_{stg}</math></b>		-55 ... +150	$^\circ\text{C}$
	Maximum lead temperature for soldering 1.6 mm (0.062 in.) from case for 10 s	300	$^\circ\text{C}$
<b><math>M_d</math></b>	Mounting torque	1.1/10	Nm/lb.in.
<b>Weight</b>		6	g

## Features

- NPT IGBT technology
- low saturation voltage
- low switching losses
- square RBSOA, no latch up
- high short circuit capability
- positive temperature coefficient for easy paralleling
- MOS input, voltage controlled
- optional ultra fast diode
- International standard packages

## Advantages

- Space savings
- High power density
- IXDT:  
surface mountable high power package

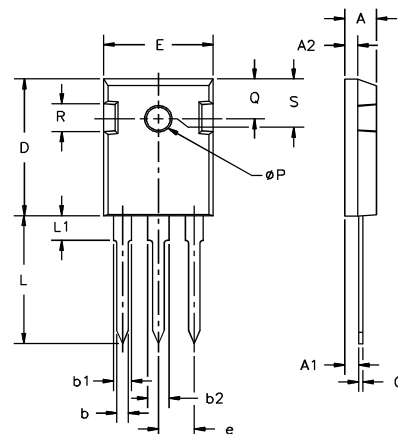
## Typical Applications

- AC motor speed control
- DC servo and robot drives
- DC choppers
- Uninterruptible power supplies (UPS)
- Switch-mode and resonant-mode power supplies

Symbol	Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$V_{(BR)CES}$	$V_{GE} = 0\text{ V}$	1200		V
$V_{GE(th)}$	$I_C = 1\text{ mA}$ , $V_{CE} = V_{GE}$	4.5		6.5 V
$I_{CES}$	$V_{CE} = V_{CES}$ $T_J = 25^\circ\text{C}$ $T_J = 125^\circ\text{C}$		2.5	1.5 mA mA
$I_{GES}$	$V_{CE} = 0\text{ V}$ , $V_{GE} = \pm 20\text{ V}$			$\pm 500\text{ nA}$
$V_{CE(sat)}$	$I_C = 30\text{ A}$ , $V_{GE} = 15\text{ V}$		2.4	2.9 V

Symbol	Conditions	Characteristic Values		
		(T <sub>J</sub> = 25°C, unless otherwise specified)		
		min.	typ.	max.
C <sub>ies</sub>	V <sub>CE</sub> = 25 V, V <sub>GE</sub> = 0 V, f = 1 MHz		1650	pF
C <sub>oes</sub>			250	pF
C <sub>res</sub>			110	pF
Q <sub>g</sub>	I <sub>C</sub> = 30 A, V <sub>GE</sub> = 15 V, V <sub>CE</sub> = 0.5 V <sub>CES</sub>		120	nC
t <sub>d(on)</sub>	Inductive load, T <sub>J</sub> = 125°C I <sub>C</sub> = 30 A, V <sub>GE</sub> = ±15 V, V <sub>CE</sub> = 600 V, R <sub>G</sub> = 47 Ω		100	ns
t <sub>r</sub>			70	ns
t <sub>d(off)</sub>			500	ns
t <sub>f</sub>			70	ns
E <sub>on</sub>			4.6	mJ
E <sub>off</sub>		3.4	mJ	
R <sub>thJC</sub>				0.42 K/W
R <sub>thCK</sub>	Package with heatsink compound		0.25	K/W

**TO-247 AD Outline**



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.7	5.3	.185	.209
A <sub>1</sub>	2.2	2.54	.087	.102
A <sub>2</sub>	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b <sub>1</sub>	1.65	2.13	.065	.084
b <sub>2</sub>	2.87	3.12	.113	.123
C	.4	.8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
e	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L1		4.50		.177
∅P	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15	BSC	.242	BSC

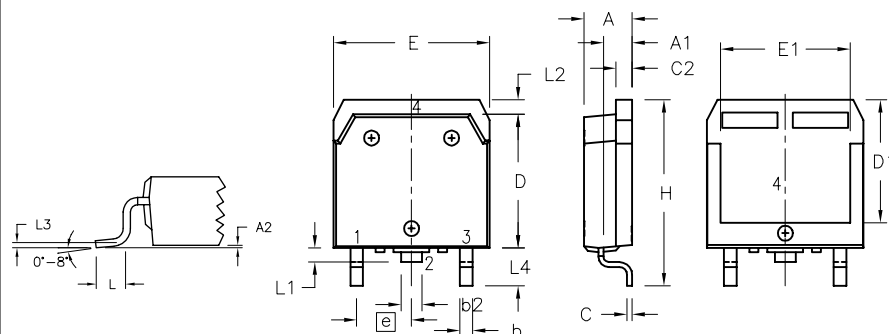
**Reverse Diode (FRED) [D1 version only]**

**Characteristic Values**

(T<sub>J</sub> = 25°C, unless otherwise specified)

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
V <sub>F</sub>	I <sub>F</sub> = 30 A, V <sub>GE</sub> = 0 V		2.5	2.7 V
	I <sub>F</sub> = 30 A, V <sub>GE</sub> = 0 V, T <sub>J</sub> = 125°C		2.0	V
I <sub>F</sub>	T <sub>C</sub> = 25°C			60 A
	T <sub>C</sub> = 90°C			35 A
I <sub>RM</sub>	I <sub>F</sub> = 30 A, -di <sub>F</sub> /dt = 400 A/μs, V <sub>R</sub> = 600 V		20	A
t <sub>rr</sub>	V <sub>GE</sub> = 0 V, T <sub>J</sub> = 125°C		200	ns
t <sub>rr</sub>	I <sub>F</sub> = 1 A, -di <sub>F</sub> /dt = 100 A/μs, V <sub>R</sub> = 30 V, V <sub>GE</sub> = 0 V		40	ns
R <sub>thJC</sub>				1 K/W

**TO-268 AA Outline**



Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.9	5.1	.193	.201
A <sub>1</sub>	2.7	2.9	.106	.114
A <sub>2</sub>	.02	.25	.001	.010
b	1.15	1.45	.045	.057
b <sub>2</sub>	1.9	2.1	.75	.83
C	.4	.65	.016	.026
D	13.80	14.00	.543	.551
E	15.85	16.05	.624	.632
E <sub>1</sub>	13.3	13.6	.524	.535
e	5.45	BSC	.215	BSC
H	18.70	19.10	.736	.752
L	2.40	2.70	.094	.106
L1	1.20	1.40	.047	.055
L2	1.00	1.15	.039	.045
L3		0.25	BSC	.010
L4	3.80	4.10	.150	.161

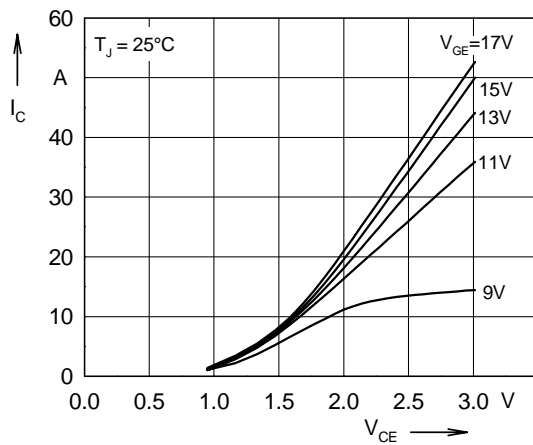


Fig. 1 Typ. output characteristics

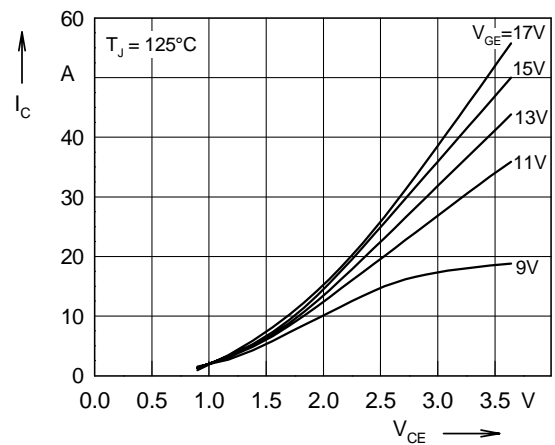


Fig. 2 Typ. output characteristics

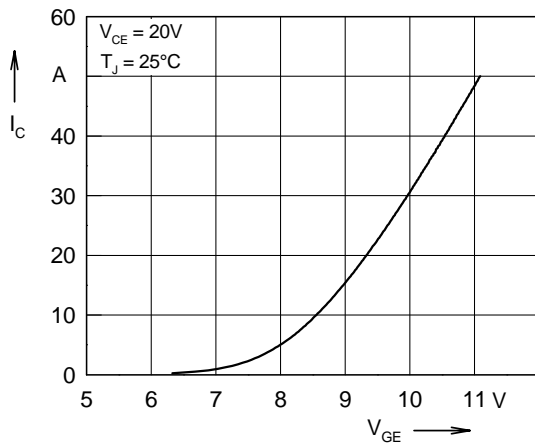


Fig. 3 Typ. transfer characteristics

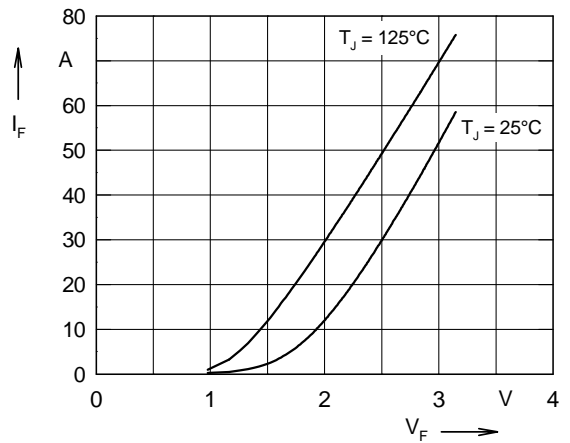


Fig. 4 Typ. forward characteristics of free wheeling diode

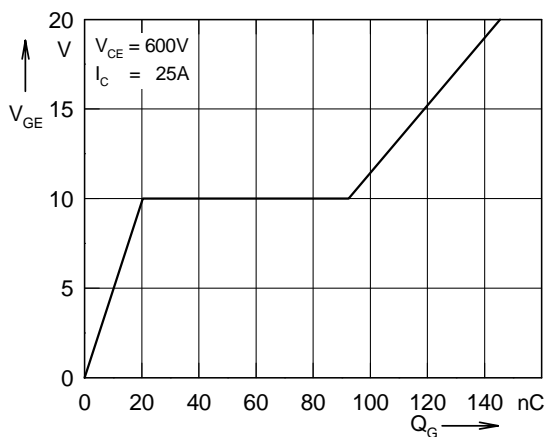


Fig. 5 Typ. turn on gate charge

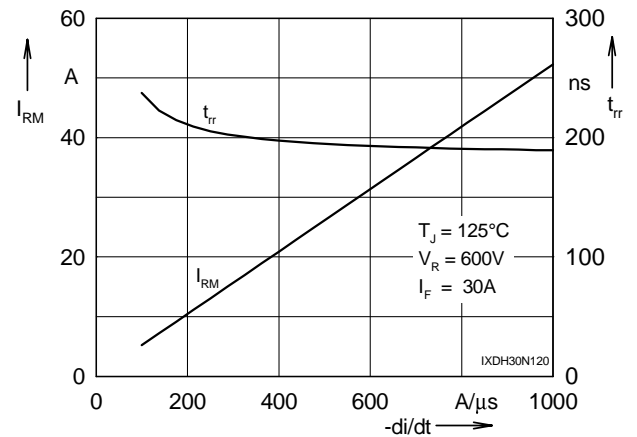


Fig. 6 Typ. turn off characteristics of free wheeling diode

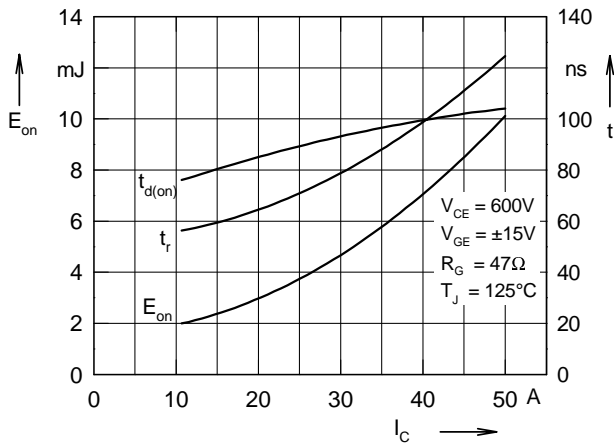


Fig. 7 Typ. turn on energy and switching times versus collector current

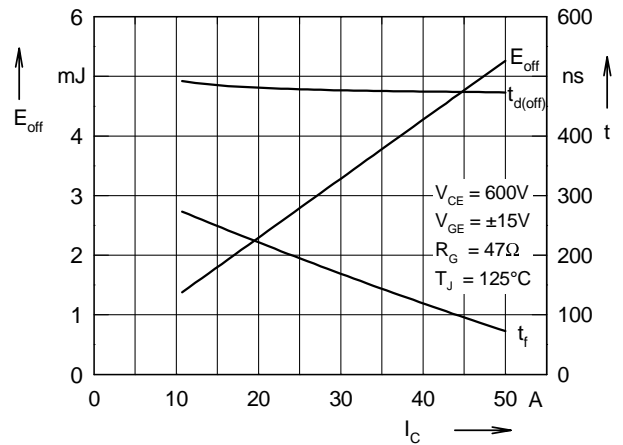


Fig. 8 Typ. turn off energy and switching times versus collector current

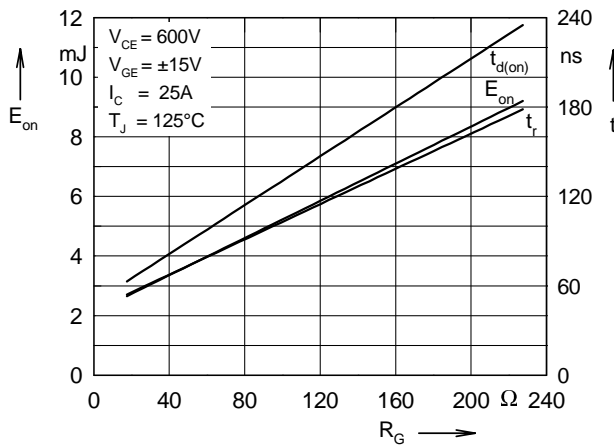


Fig. 9 Typ. turn on energy and switching times versus gate resistor

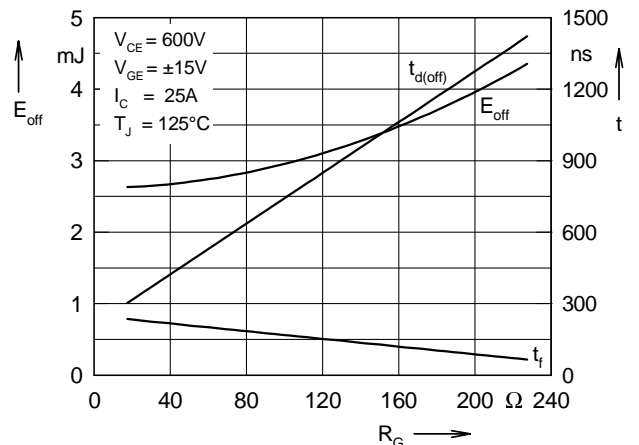


Fig. 10 Typ. turn off energy and switching times versus gate resistor

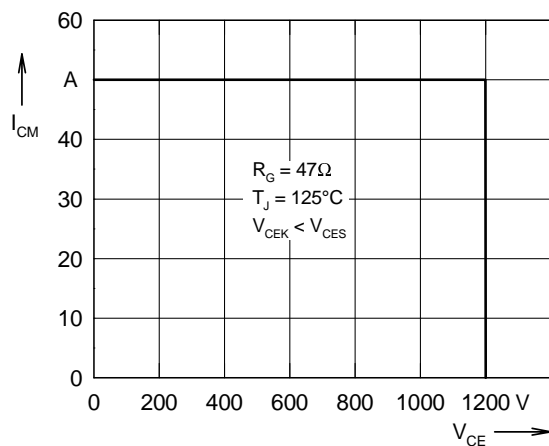


Fig. 11 Reverse biased safe operating area RBSOA

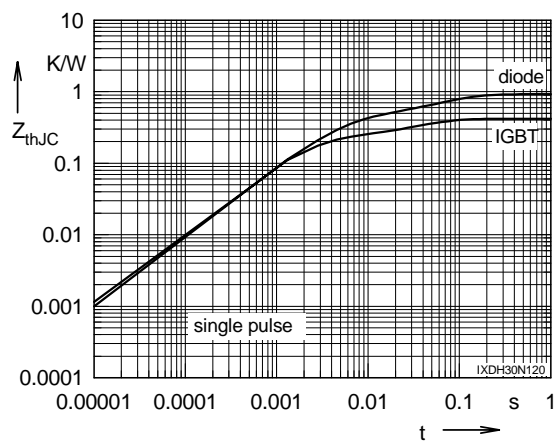


Fig. 12 Typ. transient thermal impedance